508335774 01/16/2024

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT8382966

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TOMOHARU OGITA	11/20/2020

RECEIVING PARTY DATA

Name:	SONY SEMICONDUCTOR SOLUTIONS CORPORATION
Street Address:	4-14-1 ASAHI-CHO
Internal Address:	ATSUGI-SHI
City:	KANAGAWA
State/Country:	JAPAN
Postal Code:	243-0014

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17258394

CORRESPONDENCE DATA

Fax Number: (303)863-0223

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 303-863-9700

Email: sony@sheridanross.com
Correspondent Name: SHERIDAN ROSS P.C.
Address Line 1: 1560 BROADWAY

Address Line 2: SUITE 1200

Address Line 4: DENVER, COLORADO 80202-5141

ATTORNEY DOCKET NUMBER:	6810-1398	
NAME OF SUBMITTER:	TROY D. CHRISTENSEN	
SIGNATURE:	/Troy D. Christensen/	
DATE SIGNED: 01/16/2024		
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 1

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PATENT 508335774 REEL: 066137 FRAME: 0548

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title of Invention	LIGHT-RECEIVING ELEMENT AND DISTANCE-MEASURING MODULE	
Docket Number	SYP329530US01	
As the below named in	ventor, I hereby declare that:	
This declaration	☐ The attached application, or	
is directed to:	United States application or PCT international application number PCT/JP2019/026573 filed on04 July 2019	
The above-identified a	pplication was made or authorized to be made by me.	
I believe that I am the	original inventor or an original joint inventor of a claimed invention in the application.	
	that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine t more than five (5) years, or both.	
WHEREAS,	Sony Semiconductor Solutions Corporation	
hereinafter referred to	as "ASSIGNEE") having a place of business at:	
4-14-1 Asahicho, Atsug	i-shi, Kanagawa, Japan	
application; NOW, THER acknowledged, I herelidentified United State and reissues, extensio in countries foreign to all Letters Patents issu	EFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby by assign to the ASSIGNEE, the entire right, title and interest in said invention and in the above-espatent application and in all divisions, continuations and continuations-in-part of said application, as and renewals of Letters Patent granted thereon, and in all corresponding patent applications filed the United States ("foreign countries") and corresponding international patent applications, and in ing on any such patent applications in the United States and foreign countries; and to the ASSIGNEE the right to file patent applications in foreign countries on said invention in its	
own name and the ri	ght to claim priority to the above-identified United States patent application under the terms of the ion and any other relevant treaties;	
foreign countries to is interest in and to t	sorize and request the United States Patent & Trademark Office and officials in patent offices in sue any and all of said Letters Patent to the ASSIGNEE as the assignee of my entire right, title and he same, for the sole use and behoof of the ASSIGNEE, its successors, assigns, and legal full end of the term for which said Letters Patent may be granted; and	
Further, I agree that, without further consideration, I will communicate to the ASSIGNEE any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation continuation-in-part, substitute, renewal and reissue applications, execute all necessary assignment papers to cause said Letters Patent to be issued to the ASSIGNEE, make all rightful oaths, and, perform all lawful acts to aid the ASSIGNEE, its successors and assigns, to obtain and enforce Letters Patent for said invention in the United States and foreign countries.		
LEGAL NAME OF	INVENTOR	
Inventor: TOMOHAR	U OGITA Date: 2020/11/20	
Signature: / Tomohar	u Ogita /	

RECORDED: 01/16/2024

PATENT REEL: 066137 FRAME: 0549